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XMC1200

Microcontroller Series
for Industrial Applications

XMC1000 Family

ARM® Cortex™-M0
32-bit processor core

Data Sheet

V1.4 2014-05

Microcontrollers

Edition 2014-05

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Revision History: V1.4 2014-05

Previous Version: V1.3	
Page	Subjects
Page 11	ADC channels of Table 2 is updated. Table 3 is added.
Page 12	Description for Chip Identification Number of Section 1.4 is updated.
Page 10	A new variant XMC1200-T038 is included in Table 1, Table 2 and Table 4.
Page 20	The pad type is corrected for P1.6 in Table 6.
Page 32	The t_{C12} , f_{C12}, t_{C10}, f_{C10}, t_{C8} and f_{C8} parameters are updated in Table 12.
Page 35	Figure 9 is added.
Page 38	The t_{SR} and t_{TSAL} parameters are updated in Table 15.
Page 41	Parameter name for t_{PSER} is updated. The $N_{WSFLASH}$ parameter and test condition for t_{RET} are added to Table 18.
Page 44	The min value for V_{DDPBO} parameter is added to Table 20. Footnote 1 is updated.
Page 46	The Δf_{LTT} parameter is added to Table 21.
Page 47	Figure 15 is added.

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Table of Contents

About this Document

This Data Sheet is addressed to embedded hardware and software developers. It provides the reader with detailed descriptions about the ordering designations, available features, electrical and physical characteristics of the XMC1200 series devices.

The document describes the characteristics of a superset of the XMC1200 series devices. For simplicity, the various device types are referred to by the collective term XMC1200 throughout this document.

XMC1000 Family User Documentation

The set of user documentation includes:

- **Reference Manual**
  - decribes the functionality of the superset of devices.
- **Data Sheets**
  - list the complete ordering designations, available features and electrical characteristics of derivative devices.
- **Errata Sheets**
  - list deviations from the specifications given in the related Reference Manual or Data Sheets. Errata Sheets are provided for the superset of devices.

Attention: Please consult all parts of the documentation set to attain consolidated knowledge about your device.

Application related guidance is provided by **Users Guides** and **Application Notes**.

Please refer to **http://www.infineon.com/xmc1000** to get access to the latest versions of those documents.

1 Summary of Features

The XMC1200 devices are members of the XMC1000 family of microcontrollers based on the ARM Cortex-M0 processor core. The XMC1200 series devices are optimized for LED Lighting and Human-Machine interface (HMI) applications.

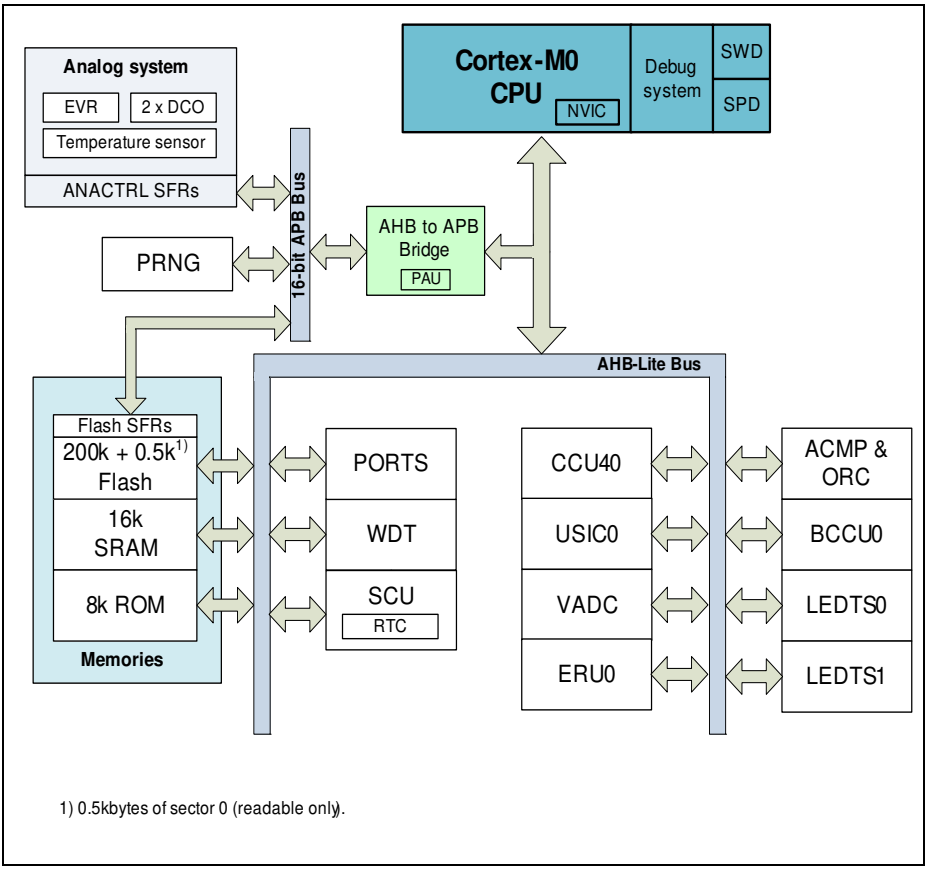

Figure 1 System Block Diagram

CPU Subsystem

- CPU Core
  - High Performance 32-bit ARM Cortex-M0 CPU
  - Most of 16-bit Thumb instruction set
  - Subset of 32-bit Thumb2 instruction set

  - High code density with 32-bit performance
  - Single cycle 32-bit hardware multiplier
  - System timer (SysTick) for Operating System support
  - Ultra low power consumption
- Nested Vectored Interrupt Controller (NVIC)
- Event Request Unit (ERU) for programmable processing of external and internal service requests

On-Chip Memories

- 8 kbytes on-chip ROM
- 16 kbytes on-chip high-speed SRAM
- up to 200 kbytes on-chip Flash program and data memory

Communication Peripherals

- Two Universal Serial Interface Channels (USIC), usable as UART, double-SPI, quad-SPI, IIC, IIS and LIN interfaces
- LED and Touch-Sense Controller (LEDTS) for Human-Machine interface

Analog Frontend Peripherals

- A/D Converters, up to 12 channels, includes 2 sample and hold stages and a fast 12-bit analog to digital converter with adjustable gain
- Up to 8 channels of out of range comparators (ORC)
- Up to 3 fast analog comparators (ACMP)
- Temperature Sensor (TSE)

Industrial Control Peripherals

- Capture/Compare Units 4 (CCU4) for use as general purpose timers
- Brightness and Colour Control Unit (BCCU), for LED color and dimming application

System Control

- Window Watchdog Timer (WDT) for safety sensitive applications
- Real Time Clock module with alarm support (RTC)
- System Control Unit (SCU) for system configuration and control
- Pseudo random number generator (PRNG), provides random data with fast generation times

Input/Output Lines

- Programmable port driver control module (PORTS)
- Individual bit addressability
- Tri-stated in input mode

- Push/pull or open drain output mode
- Configurable pad hysteresis

On-Chip Debug Support

- Support for debug features: 4 breakpoints, 2 watchpoints
- Various interfaces: ARM serial wire debug (SWD), single pin debug (SPD)

1.1 Ordering Information

The ordering code for an Infineon microcontroller provides an exact reference to a specific product. The code “XMC1<DDD>-<Z><PPP><T><FFFF>” identifies:

- <DDD> the derivatives function set
- <Z> the package variant
  - T: TSSOP
  - Q: VQFN
- <PPP> package pin count
- <T> the temperature range:
  - F: -40°C to 85°C
  - X: -40°C to 105°C
- <FFFF> the Flash memory size.

For ordering codes for the XMC1200 please contact your sales representative or local distributor.

This document describes several derivatives of the XMC1200 series, some descriptions may not apply to a specific product. Please see **Table 1**.

For simplicity the term **XMC1200** is used for all derivatives throughout this document.

1.2 Device Types

These device types are available and can be ordered through Infineon’s direct and/or distribution channels.

Table 1 Synopsis of XMC1200 **Device Types**

Derivative	Package	Flash Kbytes	SRAM Kbytes
XMC1201-T038F0016	PG-TSSOP-38-9	16	16
XMC1201-T038F0032	PG-TSSOP-38-9	32	16
XMC1201-T038F0064	PG-TSSOP-38-9	64	16
XMC1201-T038F0128	PG-TSSOP-38-9	128	16
XMC1201-T038F0200	PG-TSSOP-38-9	200	16

Table 1 Synopsis of XMC1200 Device Types (cont'd)

Derivative	Package	Flash Kbytes	SRAM Kbytes
XMC1200-T038F0200	PG-TSSOP-38-9	200	16
XMC1202-T028X0016	PG-TSSOP-28-16	16	16
XMC1202-T028X0032	PG-TSSOP-28-16	32	16
XMC1202-T016X0016	PG-TSSOP-16-8	16	16
XMC1202-T016X0032	PG-TSSOP-16-8	32	16
XMC1202-Q024X0016	PG-VQFN-24-19	16	16
XMC1202-Q024X0032	PG-VQFN-24-19	32	16
XMC1201-Q040F0016	PG-VQFN-40-13	16	16
XMC1201-Q040F0032	PG-VQFN-40-13	32	16
XMC1201-Q040F0064	PG-VQFN-40-13	64	16
XMC1201-Q040F0128	PG-VQFN-40-13	128	16
XMC1201-Q040F0200	PG-VQFN-40-13	200	16
XMC1202-Q040X0016	PG-VQFN-40-13	16	16
XMC1202-Q040X0032	PG-VQFN-40-13	32	16

1.3 Device Type Features

The following table lists the available features per device type.

Table 2 Features of XMC1200 Device Types[1)]

Derivative	ADC channel	ACMP	BCCU	LEDTS
XMC1200-T038	16	3	1	2
XMC1201-T038	16	-	-	2
XMC1202-T028	14	3	1	-
XMC1202-T016	11	2	1	-
XMC1202-Q024	13	3	1	-
XMC1201-Q040	16	-	-	2
XMC1202-Q040	16	3	1	-

1) Features that are not included in this table are available in all the derivatives

Table 3 ADC Channels [1)]

Package	VADC0 G0	VADC0 G1
PG-TSSOP-16	CH0..CH5	CH0..CH4
PG-TSSOP-28	CH0..CH7	CH0 .. CH4, CH7
PG-TSSOP-38	CH0..CH7	CH0..CH7
PG-VQFN-24	CH0..CH7	CH0..CH4
PG-VQFN-40	CH0..CH7	CH1, CH5 .. CH7

1) Some pins in a package may be connected to more than one channel. For the detailed mapping see the Port I/O Function table.

1.4 Chip Identification Number

The Chip Identification Number allows software to identify the marking. It is a 8 words value with the most significant 7 words stored in Flash configuration sector 0 (CS0) at address location : 1000 0F00$_H$ (MSB) - 1000 0F1B$_H$ (LSB). The least significant word and most significant word of the Chip Identification Number are the value of registers DBGROMID and IDCHIP, respectively.

Table 4 XMC1200 Chip Identification Number

Derivative	Value	Marking
XMC1201-T038F0016	00012012 01CF00FF 00001FF7 00006000 00000B00 00001000 00005000 101ED083$_H$	AA
XMC1201-T038F0032	00012012 01CF00FF 00001FF7 00006000 00000B00 00001000 00009000 101ED083$_H$	AA
XMC1201-T038F0064	00012012 01CF00FF 00001FF7 00006000 00000B00 00001000 00011000 101ED083$_H$	AA
XMC1201-T038F0128	00012012 01CF00FF 00001FF7 00006000 00000B00 00001000 00021000 101ED083$_H$	AA
XMC1201-T038F0200	00012012 01CF00FF 00001FF7 00006000 00000B00 00001000 00033000 101ED083$_H$	AA
XMC1200-T038F0200	00012012 01CF00FF 00001FF7 0000E000 00000B00 00001000 00033000 101ED083$_H$	AA
XMC1202-T028X0016	00012023 01CF00FF 00001FF7 00008000 00000B00 00001000 00005000 101ED083$_H$	AA
XMC1202-T028X0032	00012023 01CF00FF 00001FF7 00008000 00000B00 00001000 00009000 101ED083$_H$	AA

Table 4 XMC1200 Chip Identification Number (cont'd)

Derivative	Value	Marking
XMC1202-T016X0016	00012033 01CF00FF 00001FF7 00008000 00000B00 00001000 00005000 $101ED083_H$	AA
XMC1202-T016X0032	00012033 01CF00FF 00001FF7 00008000 00000B00 00001000 00009000 $101ED083_H$	AA
XMC1202-Q024X0016	00012063 01CF00FF 00001FF7 00008000 00000B00 00001000 00005000 $101ED083_H$	AA
XMC1202-Q024X0032	00012063 01CF00FF 00001FF7 00008000 00000B00 00001000 00009000 $101ED083_H$	AA
XMC1201-Q040F0016	00012042 01CF00FF 00001FF7 00006000 00000B00 00001000 00005000 $101ED083_H$	AA
XMC1201-Q040F0032	00012042 01CF00FF 00001FF7 00006000 00000B00 00001000 00009000 $101ED083_H$	AA
XMC1201-Q040F0064	00012042 01CF00FF 00001FF7 00006000 00000B00 00001000 00011000 $101ED083_H$	AA
XMC1201-Q040F0128	00012042 01CF00FF 00001FF7 00006000 00000B00 00001000 00021000 $101ED083_H$	AA
XMC1201-Q040F0200	00012042 01CF00FF 00001FF7 00006000 00000B00 00001000 00033000 $101ED083_H$	AA
XMC1202-Q040X0016	00012043 01CF00FF 00001FF7 00008000 00000B00 00001000 00005000 $101ED083_H$	AA
XMC1202-Q040X0032	00012043 01CF00FF 00001FF7 00008000 00000B00 00001000 00009000 $101ED083_H$	AA

2 General Device Information

This section summarizes the logic symbols and package pin configurations with a detailed list of the functional I/O mapping.

2.1 Logic Symbols

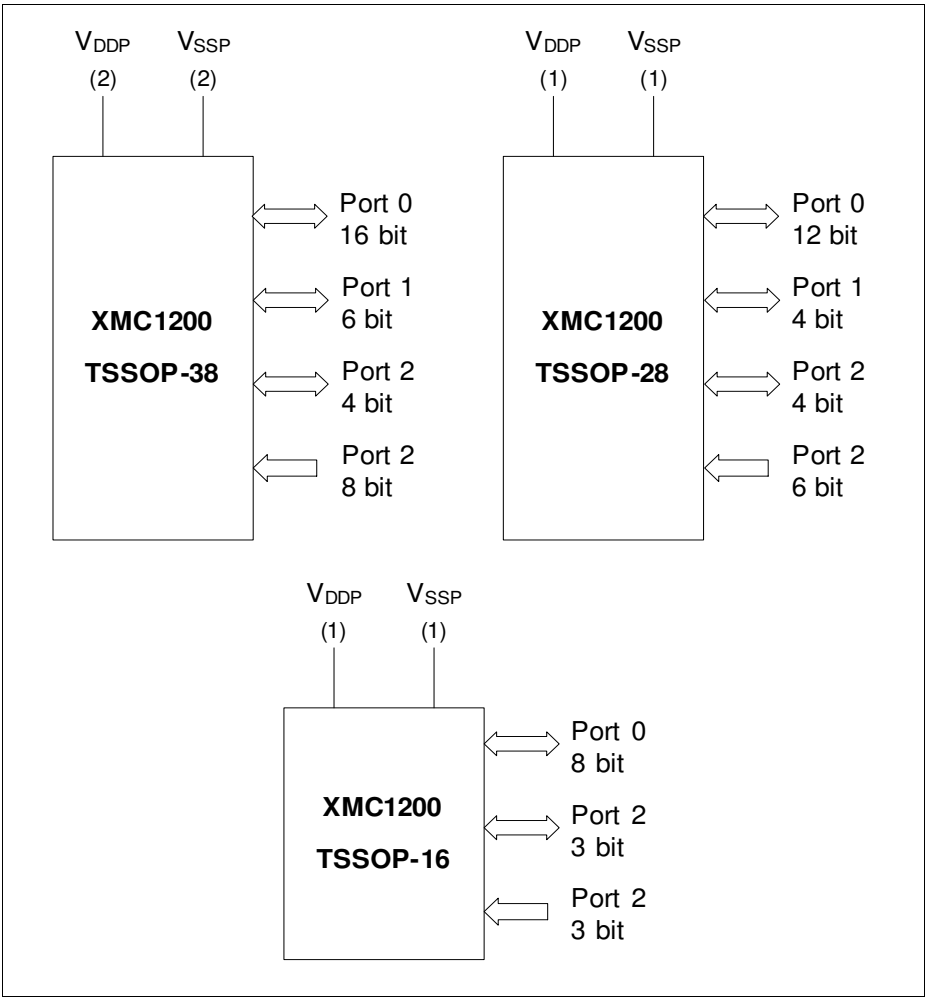

Figure 2 XMC1200 Logic Symbol for TSSOP-38, TSSOP-28 and TSSOP-16

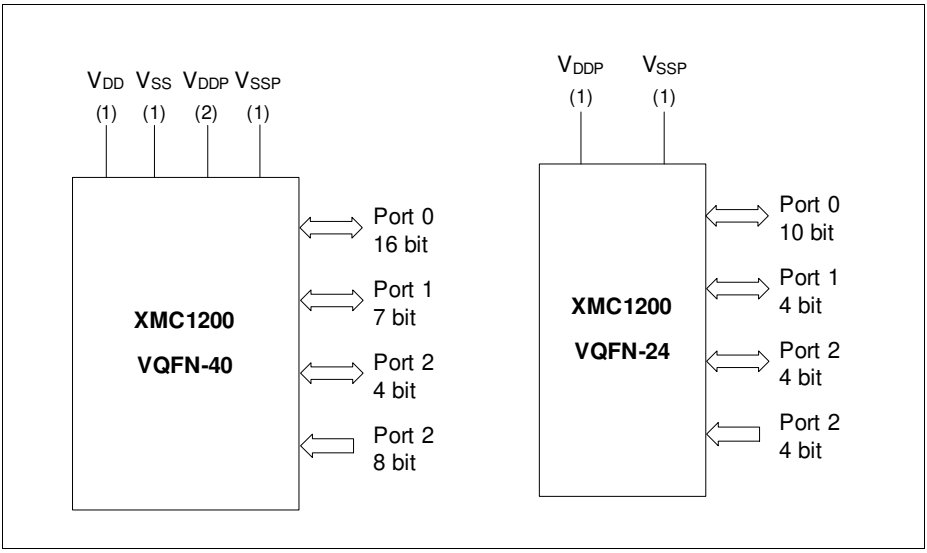

Figure 3 XMC1200 Logic Symbol for VQFN-24 and VQFN-40

2.2 Pin Configuration and Definition

The following figures summarize all pins, showing their locations on the different packages.

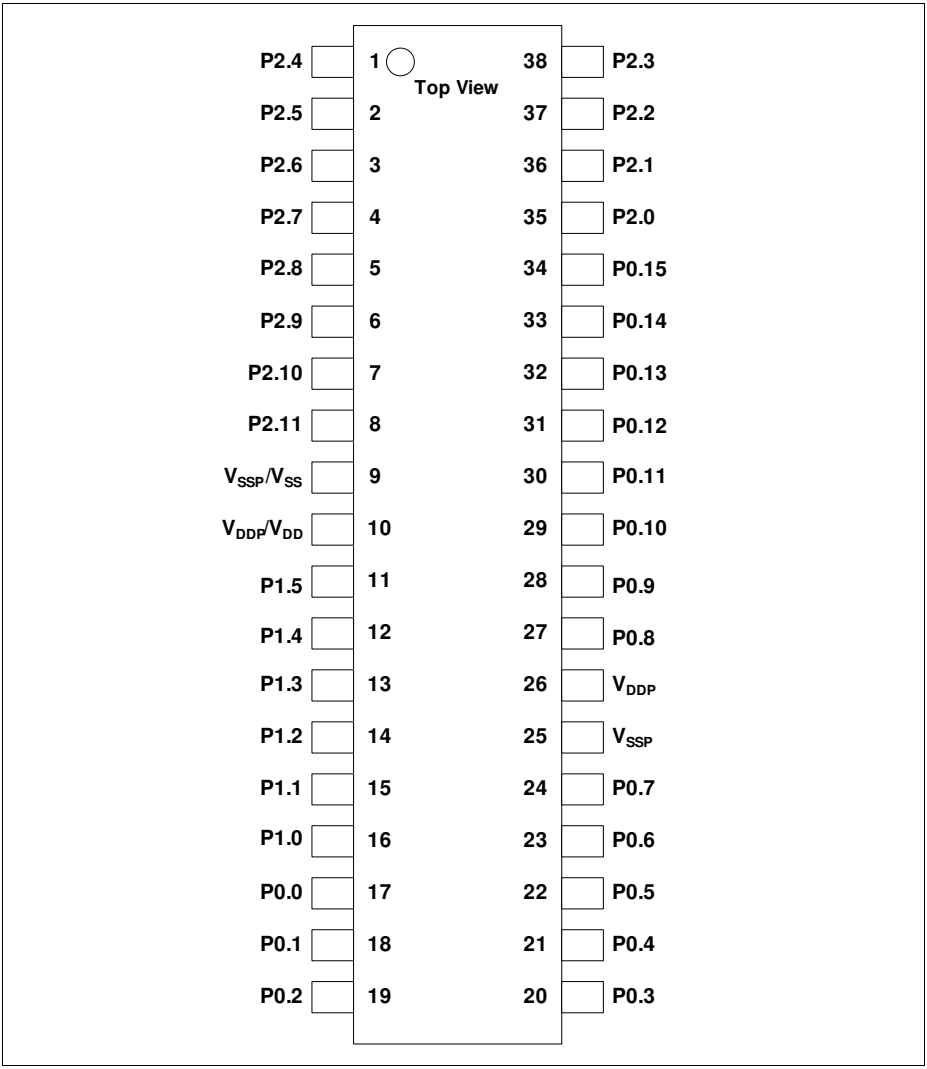

Figure 4 XMC1200 PG-TSSOP-38 Pin Configuration (top view)

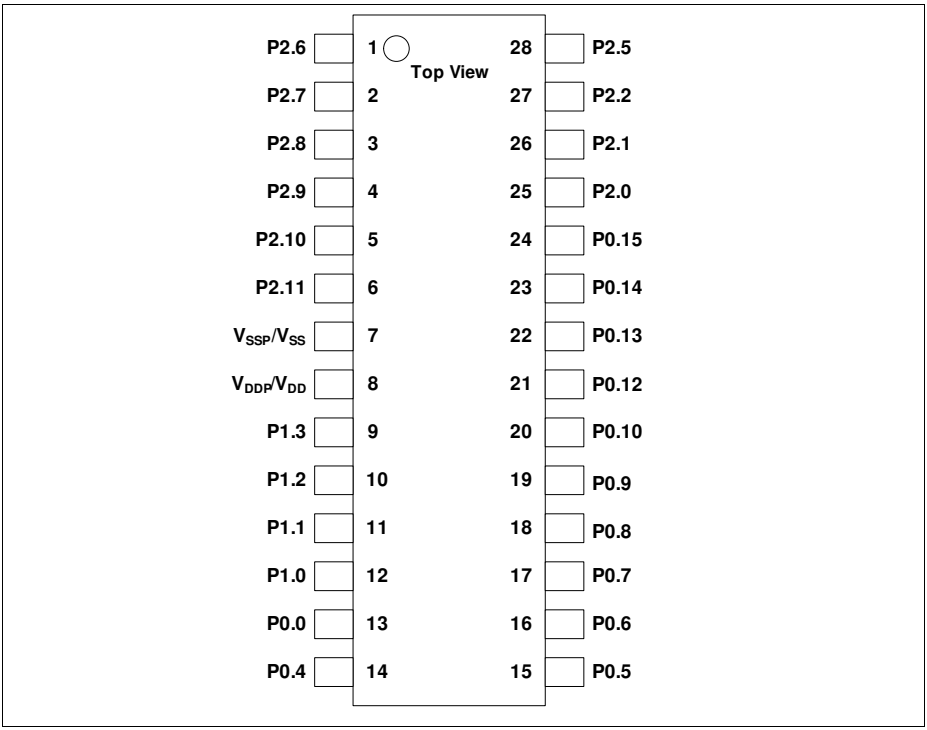

Figure 5 XMC1200 PG-TSSOP-28 Pin Configuration (top view)

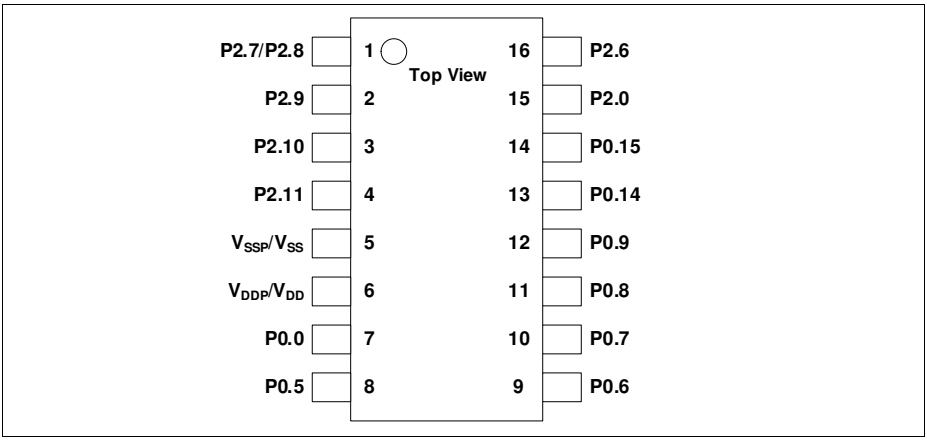

Figure 6 XMC1200 PG-TSSOP-16 Pin Configuration (top view)

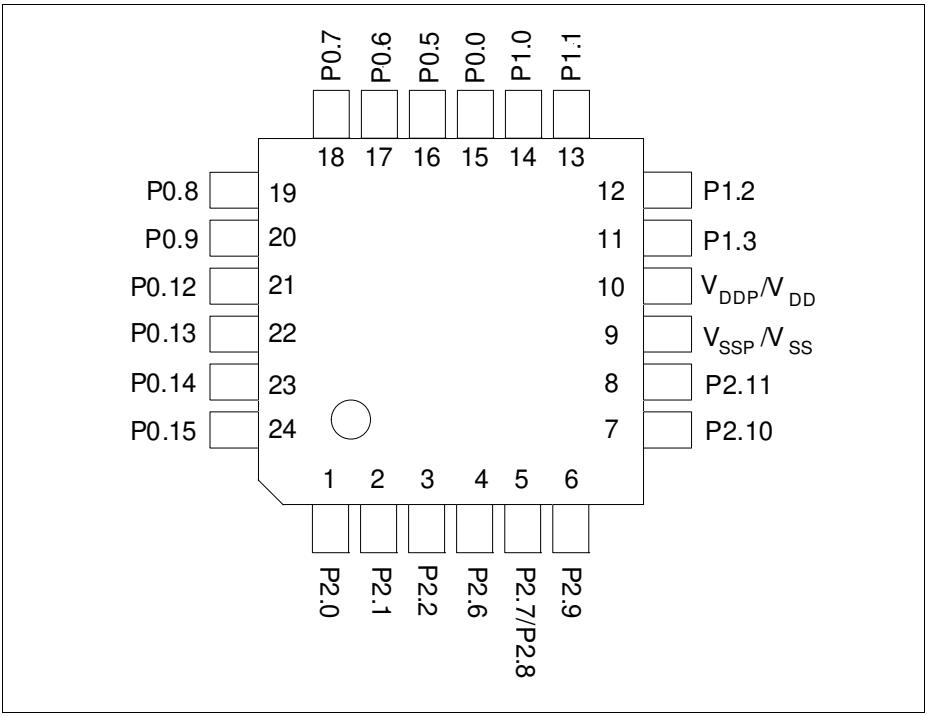

Figure 7 XMC1200 PG-VQFN-24 Pin Configuration (top view)

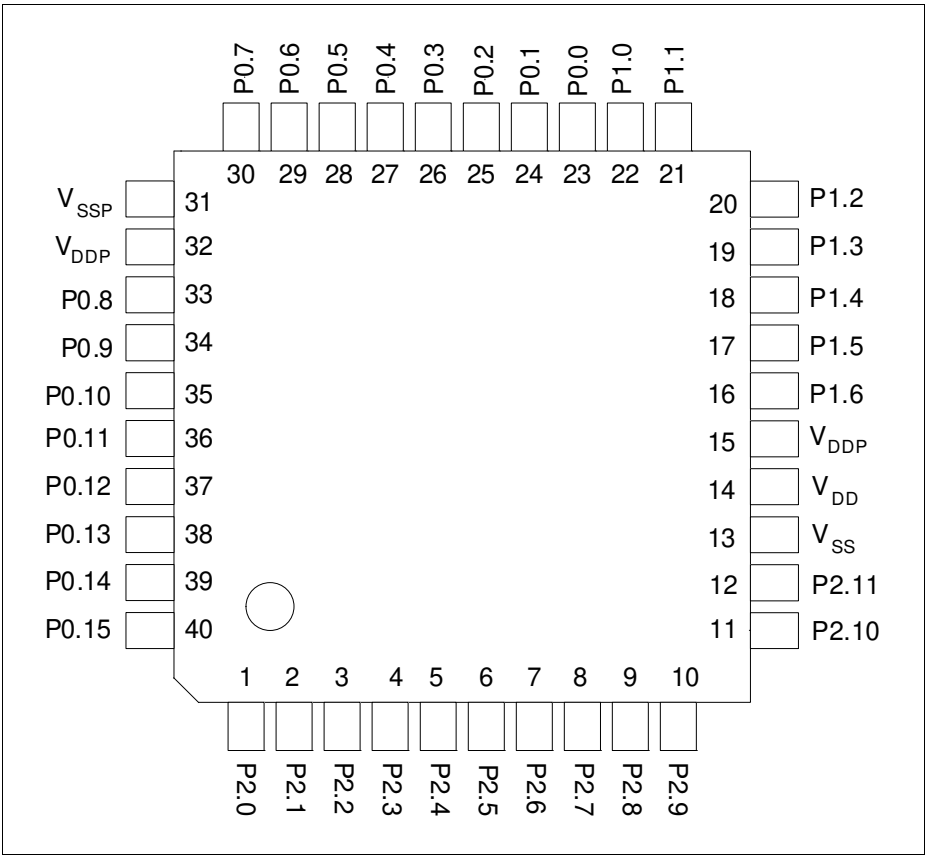

Figure 8 XMC1200 PG-VQFN-40 Pin Configuration (top view)

2.2.1 Package Pin Summary

The following general building block is used to describe each pin:

Table 5 Package Pin Mapping Description

Function	Package A	Package B	...	Pad Type
Px.y	N	N		Pad Class

The table is sorted by the “Function” column, starting with the regular Port pins (Px.y), followed by the supply pins.

The following columns, titled with the supported package variants, lists the package pin number to which the respective function is mapped in that package.

The “Pad Type” indicates the employed pad type:

- STD_INOUT (standard bi-directional pads)
- STD_INOUT/AN (standard bi-directional pads with analog input)
- High Current (high current bi-directional pads)
- STD_IN/AN (standard input pads with analog input)
- Power (power supply)

Details about the pad properties are defined in the Electrical Parameters.

Table 6 Package Pin Mapping

Function	VQFN 40	TSSOP 38	TSSOP 28	VQFN 24	TSSOP 16	Pad Type	Notes
P0.0	23	17	13	15	7	STD_INOUT	
P0.1	24	18	-	-	-	STD_INOUT	
P0.2	25	19	-	-	-	STD_INOUT	
P0.3	26	20	-	-	-	STD_INOUT	
P0.4	27	21	14	-	-	STD_INOUT	
P0.5	28	22	15	16	8	STD_INOUT	
P0.6	29	23	16	17	9	STD_INOUT	
P0.7	30	24	17	18	10	STD_INOUT	
P0.8	33	27	18	19	11	STD_INOUT	
P0.9	34	28	19	20	12	STD_INOUT	
P0.10	35	29	20	-	-	STD_INOUT	
P0.11	36	30	-	-	-	STD_INOUT	
P0.12	37	31	21	21	-	STD_INOUT	

Table 6 Package Pin Mapping

Function	VQFN 40	TSSOP 38	TSSOP 28	VQFN 24	TSSOP 16	Pad Type	Notes
P0.13	38	32	22	22	-	STD_INOUT	
P0.14	39	33	23	23	13	STD_INOUT	
P0.15	40	34	24	24	14	STD_INOUT	
P1.0	22	16	12	14	-	High Current	
P1.1	21	15	11	13	-	High Current	
P1.2	20	14	10	12	-	High Current	
P1.3	19	13	9	11	-	High Current	
P1.4	18	12	-	-	-	High Current	
P1.5	17	11	-	-	-	High Current	
P1.6	16	-	-	-	-	STD_INOUT	
P2.0	1	35	25	1	15	STD_INOUT /AN	
P2.1	2	36	26	2	-	STD_INOUT /AN	
P2.2	3	37	27	3	-	STD_IN/AN	
P2.3	4	38	-	-	-	STD_IN/AN	
P2.4	5	1	-	-	-	STD_IN/AN	
P2.5	6	2	28	-	-	STD_IN/AN	
P2.6	7	3	1	4	16	STD_IN/AN	
P2.7	8	4	2	5	1	STD_IN/AN	
P2.8	9	5	3	5	1	STD_IN/AN	
P2.9	10	6	4	6	2	STD_IN/AN	
P2.10	11	7	5	7	3	STD_INOUT /AN	
P2.11	12	8	6	8	4	STD_INOUT /AN	
VSS	13	9	7	9	5	Power	Supply GND, ADC reference GND

Table 6 Package Pin Mapping

Function	VQFN 40	TSSOP 38	TSSOP 28	VQFN 24	TSSOP 16	Pad Type	Notes
VDD	14	10	8	10	6	Power	Supply VDD, ADC reference voltage/ORC reference voltage. VDD has to be supplied with the same voltage as VDDP
VDDP	15	10	8	10	6	Power	I/O port supply
VSSP	31	25	-	-	-	Power	I/O port ground
VDDP	32	26	-	-	-	Power	I/O port supply
VSSP	Exp. Pad	-	-	Exp. Pad	-	Power	**Exposed Die Pad** The exposed die pad is connected internally to VSSP. For proper operation, it is mandatory to connect the exposed pad to the board ground. For thermal aspects, please refer to the Package and Reliability chapter.

2.2.2 Port I/O Functions

The following general building block is used to describe each PORT pin:

Table 7 Port I/O Function Description

Function	Outputs			Inputs		
	ALT1	ALTn	HWO0	HWI0	Input	Input
P0.0		MODA.OUT	MODB.OUT	MODB.INA	MODC.INA	
Pn.y	MODA.OUT				MODA.INA	MODC.INB

Pn.y is the port pin name, defining the control and data bits/registers associated with it. As GPIO, the port is under software control. Its input value is read via Pn_IN.y, Pn_OUT defines the output value.

Up to seven alternate output functions (ALT1/2/3/4/5/6/7) can be mapped to a single port pin, selected by Pn_IOCR.PC. The output value is directly driven by the respective module, with the pin characteristics controlled by the port registers (within the limits of the connected pad).

The port pin input can be connected to multiple peripherals. Most peripherals have an input multiplexer to select between different possible input sources.

The input path is also active while the pin is configured as output. This allows to feedback an output to on-chip resources without wasting an additional external pin.

By Pn_HWSEL, it is possible to select between different hardware “masters” (HWO0/HWI0, HWO1/HWI1). The selected peripheral can take control of the pin(s). Hardware control overrules settings in the respective port pin registers.

Table 8 Port I/O Functions

Function	Outputs									Inputs									
	ALT1	ALT2	ALT3	ALT4	ALT5	ALT6	ALT7	HWO0	HWO1	HWI0	HWI1	Input	Input	Input	Input	Input	Input	Input	Input
P0.0	ERU0. PDOUT0	LEDTS0. LINE7	ERU0. GOUT0	CCU40. OUT0		USIC0_CH0. SELO0	USIC0_CH1. SELO0	LEDTS0. EXTENDED7		LEDTS0. TSIN7	LEDTS0. TSIN7	BCCU0. TRAPINB	CCU40.IN0C			USIC0_CH0. DX2A	USIC0_CH1. DX2A		
P0.1	ERU0. PDOUT1	LEDTS0. LINE6	ERU0. GOUT1	CCU40. OUT1		BCCU0. OUT8	SCU. VDROP	LEDTS0. EXTENDED6		LEDTS0. TSIN6	LEDTS0. TSIN6		CCU40.IN1C						
P0.2	ERU0. PDOUT2	LEDTS0. LINE5	ERU0. GOUT2	CCU40. OUT2		VADC0. EMUX02		LEDTS0. EXTENDED5		LEDTS0. TSIN5	LEDTS0. TSIN5		CCU40.IN2C						
P0.3	ERU0. PDOUT3	LEDTS0. LINE4	ERU0. GOUT3	CCU40. OUT3		VADC0. EMUX01		LEDTS0. EXTENDED4		LEDTS0. TSIN4	LEDTS0. TSIN4		CCU40.IN3C						
P0.4	BCCU0. OUT0	LEDTS0. LINE3	LEDTS0. COL3	CCU40. OUT1		VADC0. EMUX00	WWDT. SERVICE_OUT	LEDTS0. EXTENDED3		LEDTS0. TSIN3	LEDTS0. TSIN3								
P0.5	BCCU0. OUT1	LEDTS0. LINE2	LEDTS0. COL2	CCU40. OUT0		ACMP2. OUT		LEDTS0. EXTENDED2		LEDTS0. TSIN2	LEDTS0. TSIN2								
P0.6	BCCU0. OUT2	LEDTS0. LINE1	LEDTS0. COL1	CCU40. OUT0		USIC0_CH1. MCLKOUT	USIC0_CH1. DOUT0	LEDTS0. EXTENDED1		LEDTS0. TSIN1	LEDTS0. TSIN1		CCU40.IN0B			USIC0_CH1. DX0C			
P0.7	BCCU0. OUT3	LEDTS0. LINE0	LEDTS0. COL0	CCU40. OUT1		USIC0_CH0. SCLKOUT	USIC0_CH1. DOUT0	LEDTS0. EXTENDED0		LEDTS0. TSIN0	LEDTS0. TSIN0		CCU40.IN1B			USIC0_CH0. DX1C	USIC0_CH1. DX0D	USIC0_CH1. DX1C	
P0.8	BCCU0. OUT4	LEDTS1. LINE0	LEDTS0. COLA	CCU40. OUT2		USIC0_CH0. SCLKOUT	USIC0_CH1. SCLKOUT	LEDTS1. EXTENDED0		LEDTS1. TSIN0	LEDTS1. TSIN0		CCU40.IN2B			USIC0_CH0. DX1B	USIC0_CH1. DX1B		
P0.9	BCCU0. OUT5	LEDTS1. LINE1	LEDTS0. COL6	CCU40. OUT3		USIC0_CH0. SELO0	USIC0_CH1. SELO0	LEDTS1. EXTENDED1		LEDTS1. TSIN1	LEDTS1. TSIN1		CCU40.IN3B			USIC0_CH0. DX2B	USIC0_CH1. DX2B		
P0.10	BCCU0. OUT6	LEDTS1. LINE2	LEDTS0. COL5	ACMP0. OUT		USIC0_CH0. SELO1	USIC0_CH1. SELO1	LEDTS1. EXTENDED2		LEDTS1. TSIN2	LEDTS1. TSIN2					USIC0_CH0. DX2C	USIC0_CH1. DX2C		
P0.11	BCCU0. OUT7	LEDTS1. LINE3	LEDTS0. COL4	USIC0_CH0. MCLKOUT		USIC0_CH0. SELO2	USIC0_CH1. SELO2	LEDTS1. EXTENDED3		LEDTS1. TSIN3	LEDTS1. TSIN3					USIC0_CH0. DX2D	USIC0_CH1. DX2D		
P0.12	BCCU0. OUT6	LEDTS1. LINE4	LEDTS0. COL3	LEDTS1. COL3		USIC0_CH0. SELO3		LEDTS1. EXTENDED4		LEDTS1. TSIN4	LEDTS1. TSIN4	BCCU0. TRAPINA	CCU40.IN0A	CCU40.IN1A	CCU40.IN2A	CCU40.IN3A	USIC0_CH0. DX2E		
P0.13	WWDT. SERVICE_OUT	LEDTS1. LINE5	LEDTS0. COL2	LEDTS1. COL2		USIC0_CH0. SELO4		LEDTS1. EXTENDED5		LEDTS1. TSIN5	LEDTS1. TSIN5					USIC0_CH0. DX2F			
P0.14	BCCU0. OUT7	LEDTS1. LINE6	LEDTS0. COL1	LEDTS1. COL1		USIC0_CH0. DOUT0	USIC0_CH0. SCLKOUT	LEDTS1. EXTENDED6		LEDTS1. TSIN6	LEDTS1. TSIN6					USIC0_CH0. DX0A	USIC0_CH0. DX1A		
P0.15	BCCU0. OUT8	LEDTS1. LINE7	LEDTS0. COL0	LEDTS1. COL0		USIC0_CH0. DOUT0	USIC0_CH1. MCLKOUT	LEDTS1. EXTENDED7		LEDTS1. TSIN7	LEDTS1. TSIN7					USIC0_CH0. DX0B			
P1.0	BCCU0. OUT0	CCU40. OUT0	LEDTS0. COL0	LEDTS1. COLA		ACMP1. OUT	USIC0_CH0. DOUT0		USIC0_CH0. DOUT0		USIC0_CH0. HWIN0					USIC0_CH0. DX0C			
P1.1	VADC0. EMUX00	CCU40. OUT1	LEDTS0. COL1	LEDTS1. COL0		USIC0_CH0. DOUT0	USIC0_CH1. SELO0		USIC0_CH0. DOUT1		USIC0_CH0. HWIN1					USIC0_CH0. DX0D	USIC0_CH0. DX1D	USIC0_CH1. DX2E	
P1.2	VADC0. EMUX01	CCU40. OUT2	LEDTS0. COL2	LEDTS1. COL1		ACMP2. OUT	USIC0_CH1. DOUT0		USIC0_CH0. DOUT2		USIC0_CH0. HWIN2					USIC0_CH1. DX0B			
P1.3	VADC0. EMUX02	CCU40. OUT3	LEDTS0. COL3	LEDTS1. COL2		USIC0_CH1. SCLKOUT	USIC0_CH1. DOUT0		USIC0_CH0. DOUT3		USIC0_CH0. HWIN3					USIC0_CH1. DX0A	USIC0_CH1. DX1A		
P1.4	VADC0. EMUX10	USIC0_CH1. SCLKOUT	LEDTS0. COL4	LEDTS1. COL3		USIC0_CH0. SELO0	USIC0_CH1. SELO1									USIC0_CH0. DX5E	USIC0_CH1. DX5E		
P1.5	VADC0. EMUX11	USIC0_CH0. DOUT0	LEDTS0. COLA	BCCU0. OUT1		USIC0_CH0. SELO1	USIC0_CH1. SELO2									USIC0_CH1. DX5F			

Table 8 Port I/O Functions (cont'd)

Function	Outputs									Inputs									
	ALT1	ALT2	ALT3	ALT4	ALT5	ALT6	ALT7	HWO0	HWO1	HWI0	HWI1	Input	Input	Input	Input	Input	Input	Input	Input
P1.6	VADC0. EMUX12	USIC0_CH1. DOUT0	LEDTS0. COL5	USIC0_CH0. SCLKOUT		USIC0_CH0. SELO2	USIC0_CH1. SELO3							USIC0_CH0. DX5F					
P2.0	ERU0. PDOUT3	CCU40. OUT0	ERU0. GOUT3	LEDTS1. COL5		USIC0_CH0. DOUT0	USIC0_CH0. SCLKOUT						VADC0. G0CH5		ERU0.0B0	USIC0_CH0. DX0E	USIC0_CH0. DX1E	USIC0_CH1. DX2F	
P2.1	ERU0. PDOUT2	CCU40. OUT1	ERU0. GOUT2	LEDTS1. COL6		USIC0_CH0. DOUT0	USIC0_CH1. SCLKOUT					ACMP2.INP	VADC0. G0CH6		ERU0.1B0	USIC0_CH0. DX0F	USIC0_CH1. DX3A	USIC0_CH1. DX4A	
P2.2												ACMP2.INN	VADC0. G0CH7		ERU0.0B1	USIC0_CH0. DX3A	USIC0_CH0. DX4A	USIC0_CH1. DX5A	ORC0.AIN
P2.3													VADC0. G1CH5		ERU0.1B1	USIC0_CH0. DX5B	USIC0_CH1. DX3C	USIC0_CH1. DX4C	ORC1.AIN
P2.4													VADC0. G1CH6		ERU0.0A1	USIC0_CH0. DX3B	USIC0_CH0. DX4B	USIC0_CH1. DX5B	ORC2.AIN
P2.5													VADC0. G1CH7		ERU0.1A1	USIC0_CH0. DX5D	USIC0_CH1. DX3E	USIC0_CH1. DX4E	ORC3.AIN
P2.6												ACMP1.INN	VADC0. G0CH0		ERU0.2A1	USIC0_CH0. DX3E	USIC0_CH0. DX4E	USIC0_CH1. DX5D	ORC4.AIN
P2.7												ACMP1.INP	VADC0. G1CH1		ERU0.3A1	USIC0_CH0. DX5C	USIC0_CH1. DX3D	USIC0_CH1. DX4D	ORC5.AIN
P2.8												ACMP0.INN	VADC0. G0CH1	VADC0. G1CH0	ERU0.3B1	USIC0_CH0. DX3D	USIC0_CH0. DX4D	USIC0_CH1. DX5C	ORC6.AIN
P2.9												ACMP0.INP	VADC0. G0CH2	VADC0. G1CH4	ERU0.3B0	USIC0_CH0. DX5A	USIC0_CH1. DX3B	USIC0_CH1. DX4B	ORC7.AIN
P2.10	ERU0. PDOUT1	CCU40. OUT2	ERU0. GOUT1	LEDTS1. COL4		ACMP0. OUT	USIC0_CH1. DOUT0						VADC0. G0CH3	VADC0. G1CH2	ERU0.2B0	USIC0_CH0. DX3C	USIC0_CH0. DX4C	USIC0_CH1. DX0F	
P2.11	ERU0. PDOUT0	CCU40. OUT3	ERU0. GOUT0	LEDTS1. COL3		USIC0_CH1. SCLKOUT	USIC0_CH1. DOUT0					ACMP.REF	VADC0. G0CH4	VADC0. G1CH3	ERU0.2B1	USIC0_CH1. DX0E	USIC0_CH1. DX1E		